»ULTRASURFACE« ULTRA DYNAMIC OPTICAL SYSTEMS FOR HIGH THROUGHPUT LASER SURFACE PROCESSING

Ultra SURFACE



European Commissior Horizon 2020 European Union funding for Research & Innovation

AGENDA

- **1** Motivation & goal of the ultraSURFACE project
- **2** Project relevant technologies
- **3** Concept & approach
- 4 First results
- 5 General information about the beneficiary & role in the project



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Motivation

- Surface processing techniques are widely used in industry
- Laser based processes...
 - ... offer high flexibility, precision and quality
 - ... offer new possibilities for creating complex surfaces
- The throughput of these processes is often not sufficient for an economic, industrial application
- In the same time: Laser sources getting more and more affordable



Goal

Overall goal:

Increase the throughput of laser based surface treatment processes by a factor of 10

Project title:



»Ultra Dynamic Optical Systems for High Throughput Laser Surface Processing«



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Laser processes Laser structuring (LS)

- Achieve small structures in micrometre scale
- With each pulse a tiny amount of material is removed by ablation
- Processing of 3D parts is achieved by sequential processing of tiles
- The low throughput is still limiting this technique to the processing of moulds rather than the processing of the work piece itself / individual parts





Laser processes Laser polishing (LP)

- Based on remelting a thin surface layer and smoothing the surface due to the surface tension
- Initial roughness of Ra = 1 10 µm can be reduced down to Ra = 0.05 – 0.5 µm
- Process has been adapted to 3D parts for a circular shaped beam profile
- In-house developed 3D CAM-NC process chain allows the processing of complex 3D parts using simultaneous processing
- First industrial applications already showed the potential of this new technology while the throughput is still one of the main limitations







Laser processes Laser thin-film processing (LT)



- Tool for improving the performance of technical components e.g. wear, corrosion protection or electrical conductivity
- Often a 2-step process involving the deposition of the film followed by a heat treatment
- Lasers represent a versatile alternative to conventional heat treatment: processing of thermally sensitive substrates, defined local treatment of a component
- In many fields of application requires long processing times and not adapted for complex 3D components yet







Laser processes All processes

A laser scanner is used for a fast (v>10 m/s) beam deflection in 2D/3D



For almost every application a circular shaped beam profile is used





Optical elements Piezoelectric deformable mirrors (PDM)

The shape of continuous faceplate is deformed by piezoceramic (PZT) actuators working on transverse piezoeffect





Optical elements Piezoelectric deformable mirrors (PDM)



- Low cost actuators
- Free edge
- Can be coated with all available coatings (up to 1 kW load)
- Response: 1.5 kHz
- Correction range (8 um per actuator)
 - 19 to 109 actuators
- 30 and 50 mm apertures





Optical elements Diffractive optical element (DOE)

1. Using diffraction and interference phenomenons Holoor designs a special pattern for a desired result



Image by Lookang (Wikipedia)



2. The special pattern is applied over a substrate to create the DOE using a lithography process(es)









Optical elements Diffractive optical element (DOE)







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Concept & approach

Increasing throughput



Troughput:

$$TP = \left(t_{npt} + \frac{A}{v \cdot dy \cdot n_{\text{Laser}}}\right)^{-1}$$

t _{npt}	non-prod. Time	\downarrow
A	Area	
v	Velocity	\uparrow
dy	Track offset	\uparrow
n _{Laser}	# Laser	\uparrow



Concept & approach Multi-beam, beam-shaping





Concept & approach

Adaptive beam-shaping for 2D/3D processing





Concept & approach

Adaptive multi-beam positioning for 2D/3D processing





Concept & approach S.M.A.R.T. objectives



»Ultra Dynamic Optical Systems for High Throughput Laser Surface Processing«

- SO1 Dynamic and flexible beam-shaping optics for laser surface processing
- SO2 Multi-beam optics for parallel laser surface processing
- SO3 Ultrafast synchronisation of optics and machine for 3D processing
- **SO4 Validation in industrial scenarios**



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Beam-Shaping Optics (SO1) - Concept

Analytical model for deformable mirror (PDM) shape

- PDM surface shape is calculated based on actuator voltages and integrated into optical design software
- evaluation of beam-shaping capabilities of state-of-the-art PDMs
- results for 79 channel piezo-electric DM (
 § 50 mm):



additional (static) beam-shaping element required



Beam-Shaping Optics (SO1) - Concept

Adapted concept:

- beam is pre-shaped with a rotatable diffractive optical element (DOE)
- PDM compensates for scanner and 3D-surface related distortions





Beam-Shaping Optics (SO1) - Realization





Beam-Shaping Optics (SO1) - Realization







Multi-Beam Optics (SO2) - Concept



- DOE (diffractive optical element) splits initial beam into separate beams
- 1st relay lens focuses light into intermediate focus
- 2nd relay lens images DOE into scanner
- Spot position control unit for individual beam positioning



Multi-Beam Optics (SO2) - Spot Position Control Unit



Independent x-, y- and z-positioning of each beam

- z: miniaturized focus shifter for each beam (+/- 3.5 mm)
- x + y: 2 rotatable plane-parallel glass plates per beam (+/- 400 µm)
- Compensation of:
 - Local surface tilt (>10°)
 - Distortion of spot array for large scan angles





Multi-Beam Optics (SO2) - Spot Position Control Unit





Multi-Beam Optics (SO2) - Realization





Machine Tool (SO3) - Concept

- Mechanical engineering
 - 5 numerical axis
 - granite base
 - measurement probe integrated
- Utilities (electrical, pneumatics, safety, ...
 - protective atmosphere
 - suitable laser safety housing





Machine Tool (SO3) - Realization





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Consortium





Contacts & role in the project

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